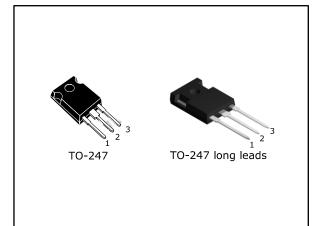
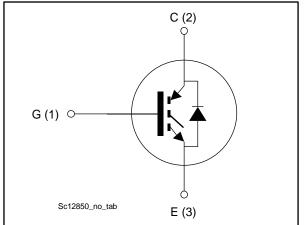


# Trench gate field-stop IGBT, M series 650 V, 75 A low-loss in TO-247 and TO-247 long leads packages

Datasheet - production data



#### Figure 1: Internal schematic diagram



#### **Features**

- 6 µs of short-circuit withstand time
- V<sub>CE(sat)</sub> = 1.65 V (typ.) @ I<sub>C</sub> = 75 A
- Tight parameter distribution
- Safer paralleling
- Positive V<sub>CE(sat)</sub> temperature coefficient
- Low thermal resistance
- Soft and very fast recovery antiparallel diode
- Maximum junction temperature: T<sub>J</sub> = 175 °C

#### **Applications**

- Motor control
- UPS
- PFC
- General purpose inverter

### Description

These devices are IGBTs developed using an advanced proprietary trench gate field-stop structure. The devices are part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive  $V_{CE(sat)}$  temperature coefficient and tight parameter distribution result in safer paralleling operation.

#### Table 1: Device summary

Order code	Marking	Package	Packing
STGW75M65DF2		TO-247	Tube
STGWA75M65DF2	G75M65DF2	TO-247 long leads	Tube

This is information on a product in full production.

#### Contents

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### 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VCES	Collector-emitter voltage (V <sub>GE</sub> = 0 V)	650	V
lc <sup>(1)</sup>	Continuous collector current at T <sub>C</sub> = 25 °C	120	А
lc	Continuous collector current at T <sub>c</sub> = 100 °C	75	А
Icp <sup>(2)</sup>	Pulsed collector current	225	А
V <sub>GE</sub>	Gate-emitter voltage	±20	V
IF <sup>(1)</sup>	Continuous forward current at T <sub>C</sub> = 25 °C	120	А
lF	Continuous forward current at T <sub>C</sub> = 100 °C	75	А
I <sub>FP</sub> <sup>(2)</sup>	Pulsed forward current	225	А
Ртот	Total dissipation at $T_c = 25 \ ^{\circ}C$ 468		W
Tstg	Storage temperature range - 55 to 150		°C
TJ	Operating junction temperature range	- 55 to 175	°C

#### Notes:

<sup>(1)</sup>Current level is limited by bond wires

 $\ensuremath{^{(2)}}\ensuremath{\mathsf{Pulse}}$  width limited by maximum junction temperature.

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case IGBT	0.32	°C/W
R <sub>thJC</sub>	Thermal resistance junction-case diode	0.74	°C/W
RthJA	Thermal resistance junction-ambient	50	°C/W



### 2 Electrical characteristics

 $T_C = 25$  °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE}$ = 0 V, I <sub>C</sub> = 250 µA	650			V
		$V_{GE}$ = 15 V, I <sub>C</sub> = 75 A		1.65	2.1	
V <sub>CE(sat)</sub> Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 75 A, T <sub>J</sub> = 125 °C		1.95		V	
	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 75 \text{ A},$ T <sub>J</sub> = 175 °C		2.1			
		I <sub>F</sub> = 75 A		2	2.85	
VF	Forward on-voltage	I <sub>F</sub> =75 A, T <sub>J</sub> = 125 °C		1.75		V
		I <sub>F</sub> = 75 A, T <sub>J</sub> = 175 °C		1.6		
$V_{\text{GE(th)}}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 2 \text{ mA}$	5	6	7	V
ICES	Collector cut-off current	$V_{GE} = 0 V, V_{CE} = 650 V$			25	μA
I <sub>GES</sub>	Gate-emitter leakage current	$V_{CE} = 0 V, V_{GE} = \pm 20 V$			±250	μA

#### Table 4: Static characteristics

#### Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	6290	-	
Coes	Output capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0 V	-	390	-	pF
Cres	Reverse transfer capacitance		-	136	-	
Qg	Total gate charge	Vcc = 520 V, Ic = 75 A,	-	225	-	
Q <sub>ge</sub>	Gate-emitter charge	V <sub>GE</sub> = 0 to 15 V (see <i>Figure 30:</i> " <i>Gate</i>	-	53	-	nC
Q <sub>gc</sub>	Gate-collector charge	charge test circuit")	-	87	-	



#### Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Symbol		Test conditions		тур.	IVIAA.	Unit
t <sub>d(on)</sub>	Turn-on delay time			47	-	ns
tr	Current rise time			22.4	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 75 A,		2680	-	A/µs
t <sub>d(off)</sub>	Turn-off-delay time	$V_{GE} = 15 \text{ V}, \text{ R}_{G} = 3.3 \Omega$		125	-	ns
t <sub>f</sub>	Current fall time	<ul> <li>(see Figure 29: "Test circuit for inductive load</li> </ul>		93	-	ns
Eon <sup>(1)</sup>	Turn-on switching energy	switching")		0.69	-	mJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy			2.54	-	mJ
Ets	Total switching energy			3.23	-	mJ
t <sub>d(on)</sub>	Turn-on delay time			48	-	ns
tr	Current rise time			25	-	ns
(di/dt) <sub>on</sub>	Turn-on current slope	$V_{CE} = 400 \text{ V}, \text{ I}_{C} = 75 \text{ A},$ $V_{GE} = 15 \text{ V}, \text{ R}_{G} = 3.3 \Omega$		2420	-	A/µs
t <sub>d(off)</sub>	Turn-off-delay time	$T_{\rm J} = 175 ^{\circ}{\rm C}$		125	-	ns
tf	Current fall time	(see Figure 29: "Test		167	-	ns
Eon <sup>(1)</sup>	Turn-on switching energy	<pre>circuit for inductive load switching")</pre>		2.17	-	mJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy			3.45	-	mJ
Ets	Total switching energy			5.62	-	mJ
	t <sub>sc</sub> Short-circuit withstand time	$\label{eq:Vcc} \begin{array}{l} V_{CC} \leq 400 \ \text{V}, \ \text{V}_{GE} = 13 \ \text{V}, \\ T_{J\text{start}} \leq 150 \ ^{\circ}\text{C} \end{array}$	10		-	
LSC		$\label{eq:VCC} \begin{array}{l} V_{CC} \leq 400 \mbox{ V}, \mbox{ V}_{GE} = 15 \mbox{ V}, \\ T_{Jstart} \leq 150 \mbox{ °C} \end{array}$	6			μs

#### Table 6: IGBT switching characteristics (inductive load)

#### Notes:

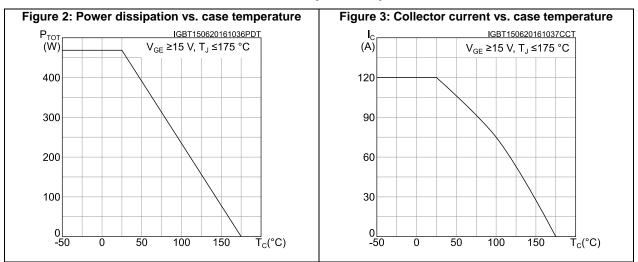
<sup>(1)</sup>Including the reverse recovery of the diode. <sup>(2)</sup>Including the tail of the collector current.

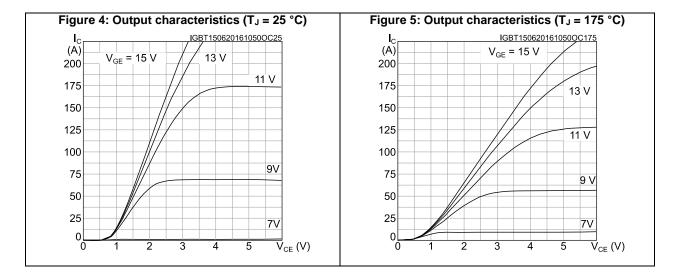
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
trr	Reverse recovery time		-	165	-	ns
Qrr	Reverse recovery charge	I <sub>F</sub> = 75 A, V <sub>R</sub> = 400 V, V <sub>GE</sub> = 15 V,	-	1.72	-	μC
Irrm	Reverse recovery current	di/dt = 1000 A/µs	-	25	-	А
dlrr/dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>	(see Figure 29: " Test circuit for inductive load switching")	-	750	-	A/µs
Err	Reverse recovery energy	Switching (	-	289	-	μJ
t <sub>rr</sub>	Reverse recovery time	I <sub>F</sub> = 75 A, V <sub>R</sub> = 400 V,	-	256	-	ns
Qrr	Reverse recovery charge	V <sub>GE</sub> = 15 V,	-	6.85	-	μC
Irrm	Reverse recovery current	di/dt = 1000 A/µs, TJ = 175 °C	-	48	-	А
dlrr/dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>	(see Figure 29: " Test circuit for inductive load	-	300	-	A/µs
Err	Reverse recovery energy	switching")	-	1033	-	μJ

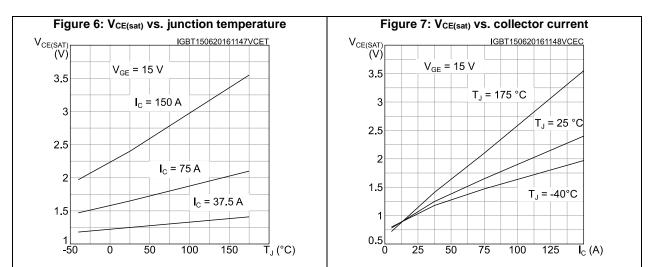
Table 7: Diode switching characteristics (in	nductive load)
Table 7. Diode Switching characteristics (i	nuuciive ioauj



### 2.1 Electrical characteristics (curves)



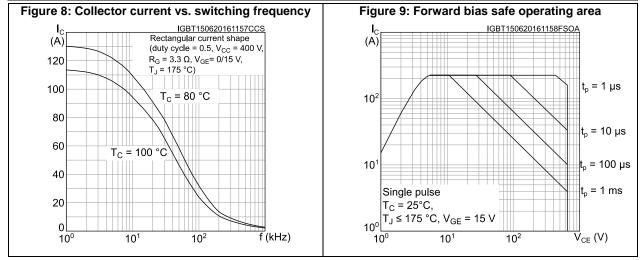


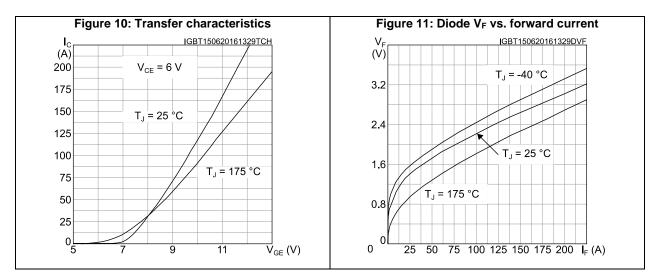


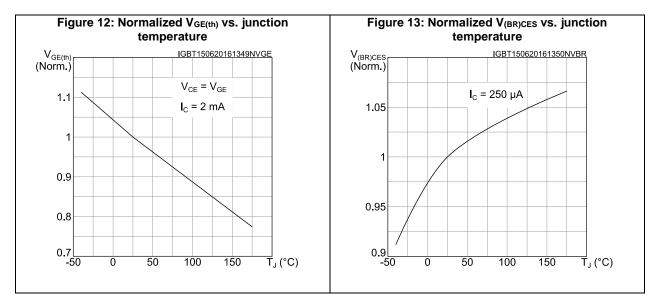


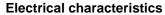
57

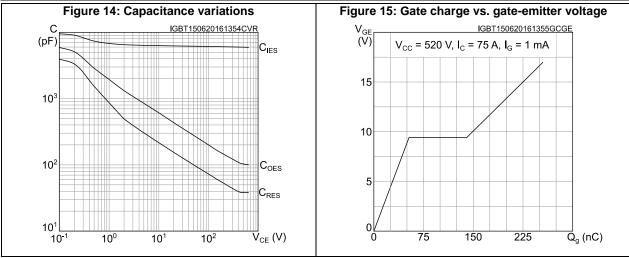
#### **Electrical characteristics**

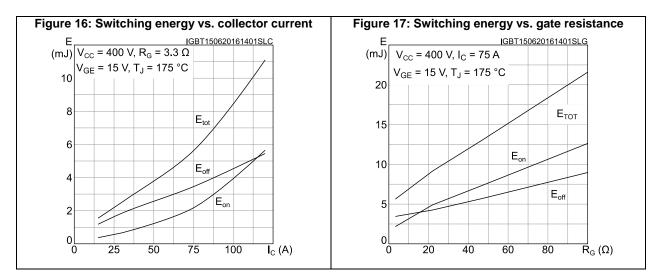


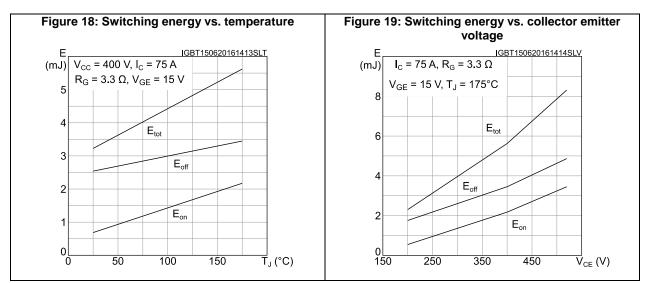








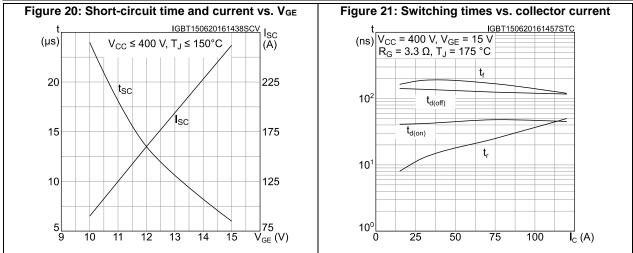


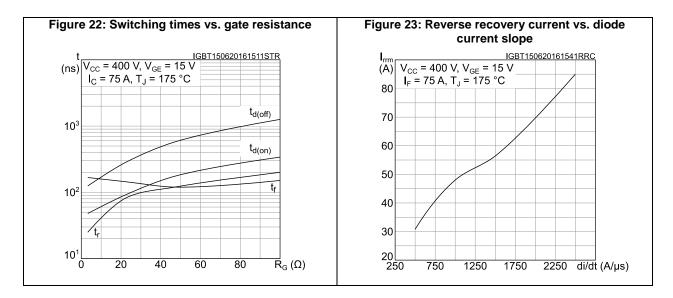


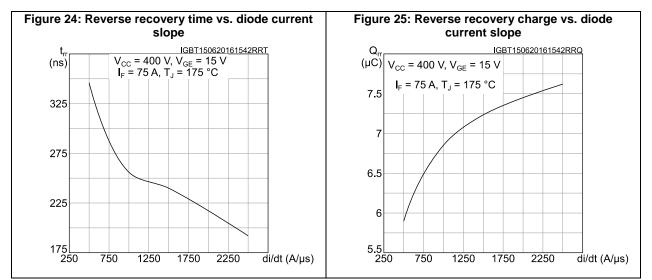


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#### **Electrical characteristics**

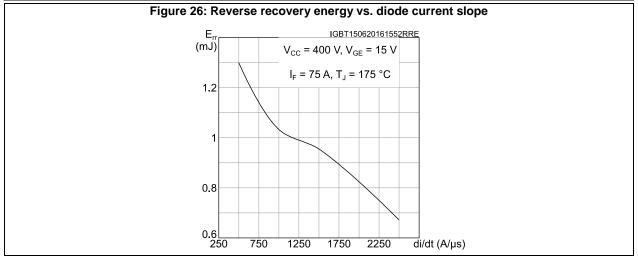


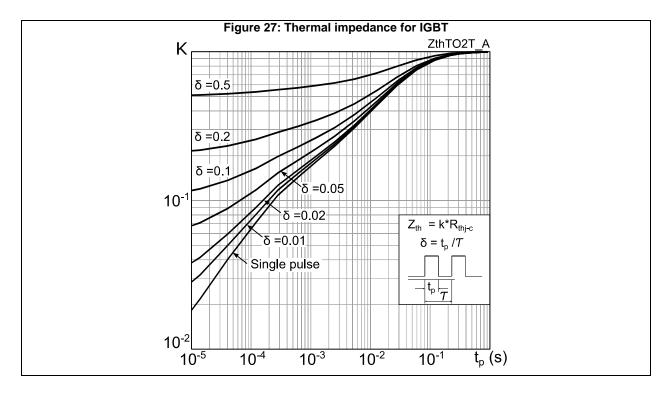




#### **Electrical characteristics**

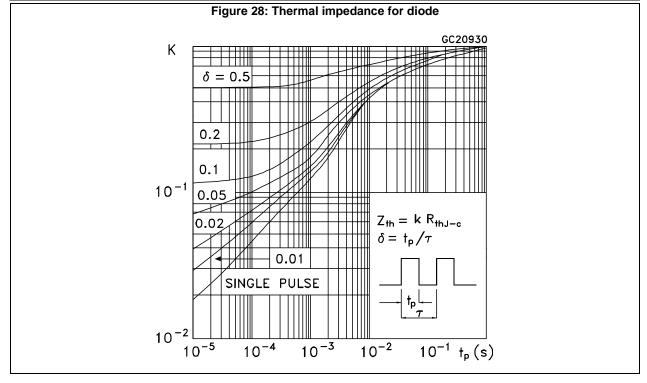
#### STGW75M65DF2, STGWA75M65DF2





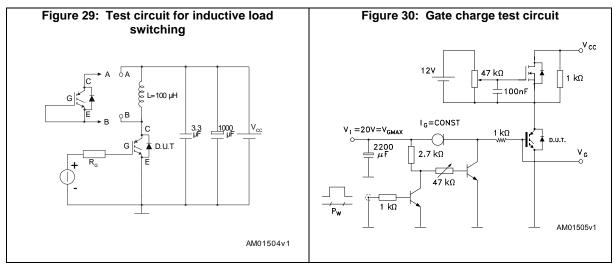


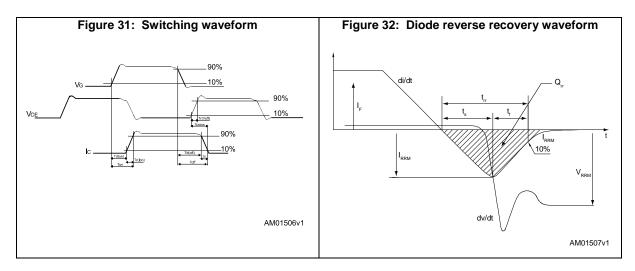
#### **Electrical characteristics**





### 3 Test circuits





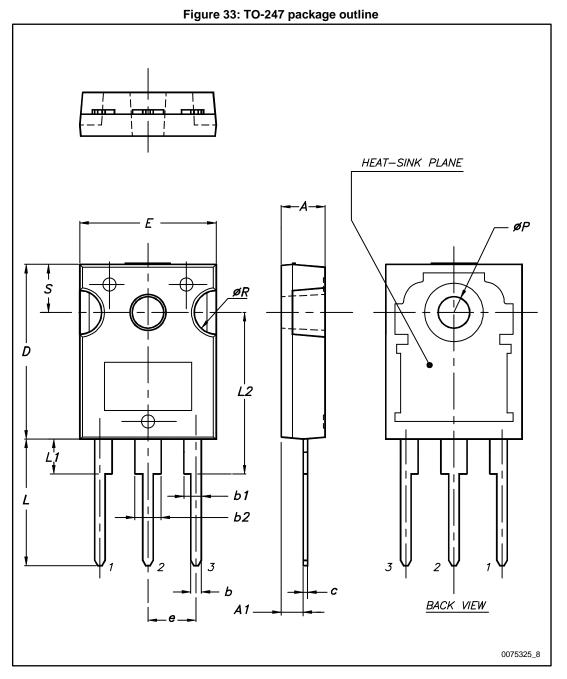


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### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

### 4.1 TO-247 package information



#### Package information

#### STGW75M65DF2, STGWA75M65DF2

	Table 8: TO-247 pac	kage mechanical data	2, 010114101100012		
Dim		mm			
Dim.	Min.	Тур.	Max.		
A	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
E	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		



### 4.2 TO-247 long leads package information

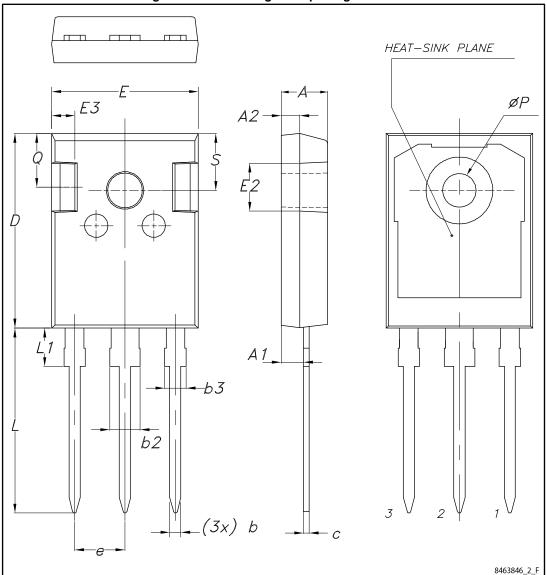


Figure 34: TO-247 long leads package outline



#### Package information

#### STGW75M65DF2, STGWA75M65DF2

Table 9: TO-247 long leads package mechanical data			
	mm		
Min.	Тур.	Max.	
4.90	5.00	5.10	
2.31	2.41	2.51	
1.90	2.00	2.10	
1.16		1.26	
		3.25	
		2.25	
0.59		0.66	
20.90	21.00	21.10	
15.70 15.80		15.90	
4.90	5.00	5.10	
2.40	2.50	2.60	
5.34	5.44	5.54	
19.80	19.92	20.10	
		4.30	
3.50	3.60	3.70	
5.60		6.00	
6.05	6.15	6.25	
	Min. 4.90 2.31 1.90 1.16 0.59 20.90 15.70 4.90 2.40 5.34 19.80 3.50 5.60	mm           Min.         Typ.           4.90         5.00           2.31         2.41           1.90         2.00           1.16	



### 5 Revision history

Date	Revision	Changes	
02-Dec-2015	1	First release.	
15-Jun-2016	2	Inserted device in TO-247 and document updated accordingly. Inserted Section 2.1: "Electrical characteristics (curves)". Document status promoted from preliminary to production data. Minor text changes.	
03-May-2017	3	Modified: title, features and application on cover page. Modified Table 4: "Static characteristics", Table 7: "Diode switching characteristics (inductive load)" and Figure 13: "Normalized V <sub>(BR)CES</sub> vs. junction temperature ". Minor text changes.	

#### Table 10: Document revision history



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